



## 概述

HXY542 是一款基于 BCDMOS 技术设计的霍尔开关传感器。传感器包括具有温度补偿的 hall 器件、动态失调消除放大器、比较器和输出级。该芯片为电流输出。比较器将实际磁通量与固定参考值（开关点）进行比较，控制输出 MOSFET 的电流大小。有源失调补偿可在各种电源电压下产生特定温度系数的磁特性。此外，机械应力对磁性参数影响很小。

该系列芯片传感器适用于工业环境和汽车应用，环境温度范围为 $-40^{\circ}\text{C} \sim 150^{\circ}\text{C}$ ，电源电压范围为 $3.0\text{V} \sim 30\text{V}$ 。HXY542有三种封装形式：TO-92S、SOT-23、SOT-23-3L，且封装符合 RoHS 标准。

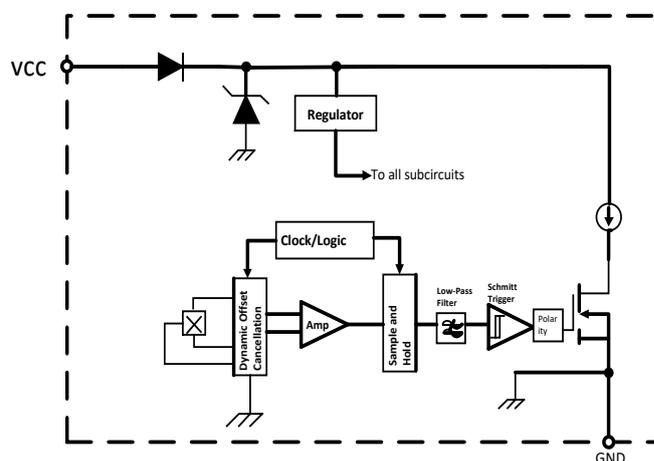
## 特征

- 工作电压： $3.0\text{V} \sim 30\text{V}$
- 有较强的机械应力抑制能力
- ESD 性能： $\pm 12\text{kV}$
- 电源引脚反向电压保护
- 电源引脚具有电压保护
- 工作温度范围： $-40^{\circ}\text{C} \sim 150^{\circ}\text{C}$
- 温度升高引起的磁通密度的降低由内置负温度系数来补偿

## 典型应用

- 速度和 RPM 传感器
- 转速表传感器、流量传感器
- 流电动机、电机和风扇控制、机器人控制
- 近距离传感器、位置传感器
- 安全扣带、引擎盖、后备箱门锁
- 天窗/活顶/后挡板/提升门启动
- 刹车/离合器踏板
- 电动助力转向系统 (EPS)
- 变速器换挡

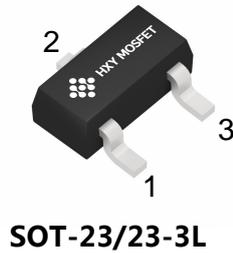
## 功能框图



HXY542 功能框图



## 引脚信息



| 芯片引脚号 | 名称  | 说明       |
|-------|-----|----------|
| 1     | VCC | 电源       |
| 2     | GND | 地        |
| 3     | NC  | NC (未定义) |

## 订购信息

| 产品型号     | 封装形式      | 温度范围        | 成品包装      |
|----------|-----------|-------------|-----------|
| HXY542UA | TO-92S    | -40°C~150°C | 1000pcs/袋 |
| HXY542SU | SOT-23-3L | -40°C~150°C | 3000pcs/盘 |
| HXY542SS | SOT-23    | -40°C~150°C | 3000pcs/盘 |

## 绝对最大额定

绝对最大值是应用芯片时的极限值，超过该值可能会损坏芯片。尽管在超过该值时芯片的功能不一定受到损害，但是如果在规定时间内超过该值，则芯片的可靠性可能会受到影响。

| 符号              | 参数     | 引脚号 | 最小值 | 最大值 | 单位 | 条件                    |
|-----------------|--------|-----|-----|-----|----|-----------------------|
| V <sub>CC</sub> | 电源电压   | 1   | -20 | 30  | V  | t<1000h <sup>1)</sup> |
|                 |        |     |     | 34  | V  | t<96h <sup>1)</sup>   |
|                 |        |     |     | 36  | V  | t<5min <sup>1)</sup>  |
| T <sub>A</sub>  | 操作环境温度 |     | -40 | 170 | °C | t<96h <sup>1)</sup>   |
| T <sub>S</sub>  | 存储温度   |     | -65 | 170 | °C |                       |
| T <sub>J</sub>  | 最大结温   |     |     | 165 | °C |                       |

<sup>1)</sup>无累积应力



## 推荐操作条件

当芯片的工作超出推荐操作条件中所述的范围，可能会导致芯片工作异常，并可能降低可靠性和使用寿命。

| 符号       | 参数     | 引脚号 | 最小值 | 典型值 | 最大值 | 单位 |
|----------|--------|-----|-----|-----|-----|----|
| $V_{CC}$ | 电源电压   | 1   | 3.0 |     | 30  | V  |
| $T_A$    | 操作环境温度 |     | -40 |     | 150 | °C |

## ESD参数

| 符号        | 描述         | 执行标准              | 最大值 | 单位 |
|-----------|------------|-------------------|-----|----|
| $V_{ESD}$ | 人体放电模式 HBM | JEDEC JS-001-2017 | 12  | kV |

## 电学参数

测试条件： $V_{CC}=3.0V\sim 30V$ ， $T_A=-40^{\circ}C\sim 150^{\circ}C$

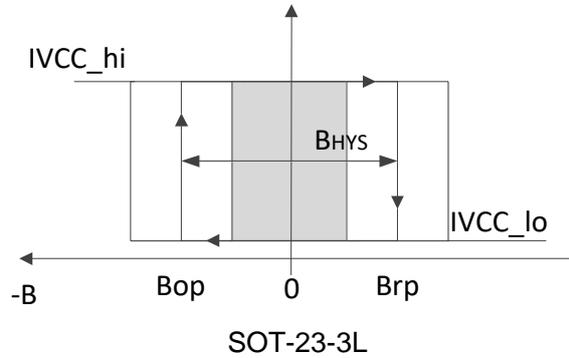
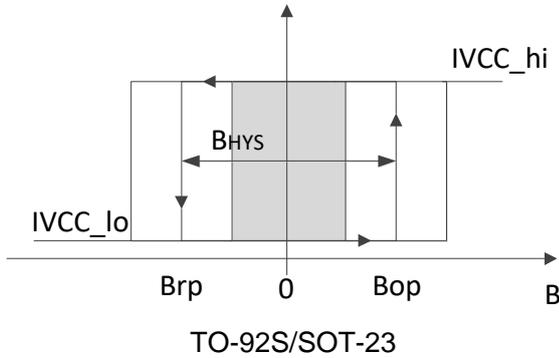
| 符号            | 参数       | 引脚号 | 最小值 | 典型值 | 最大值 | 单位 | 条件             |
|---------------|----------|-----|-----|-----|-----|----|----------------|
| $I_{VCC\_LO}$ | 电源低电流    | 1   | 4.0 | 6.0 | 8.0 | mA | $B > B_{rp}$   |
| $I_{VCC\_HI}$ | 电源高电流    | 1   | 12  | 15  | 18  | mA | $B < B_{op}$   |
| $I_{CCR}$     | 电源反向电流   |     |     |     | 1   | mA | $V_{CC}=-18V$  |
| $B_{NOISE}$   | 开关点的有效噪声 |     |     | 1   |     | Gs | 适用于 1kHz 的方波信号 |

## 磁场参数

| 芯片     | 切换类型 | 温度系数<br>TC (ppm/K) | 工作点 (Gs) |     |     | 释放点 (Gs) |      |     | 回差 (Gs) |     |     |
|--------|------|--------------------|----------|-----|-----|----------|------|-----|---------|-----|-----|
|        |      |                    | 最小值      | 典型值 | 最大值 | 最小值      | 典型值  | 最大值 | 最小值     | 典型值 | 最大值 |
| HXY542 | 双极   | 0                  |          | 121 |     |          | -121 |     |         | 242 |     |

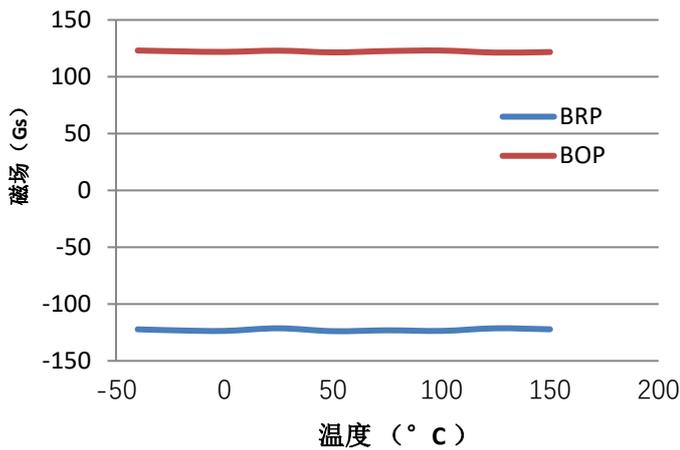


### 磁电转换说明

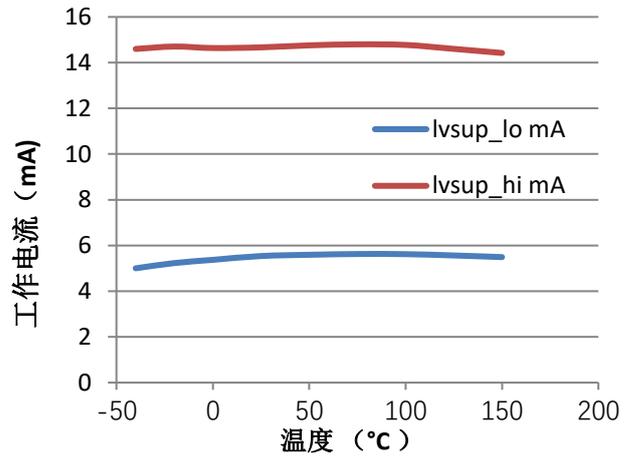


### 特性曲线

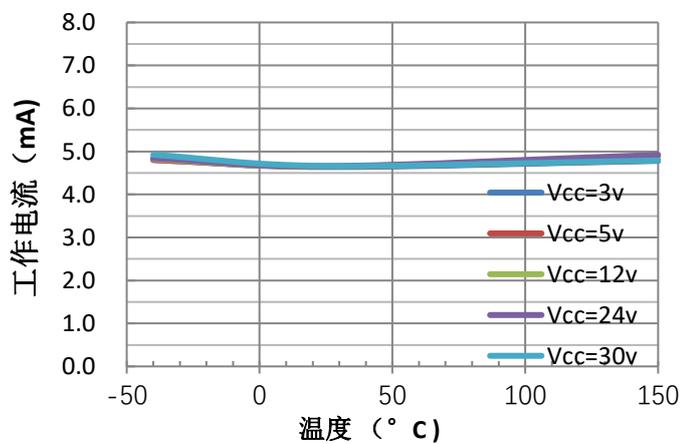
$V_{CC}=5V$ , Bop 和 Brp 随温度变化特性曲线



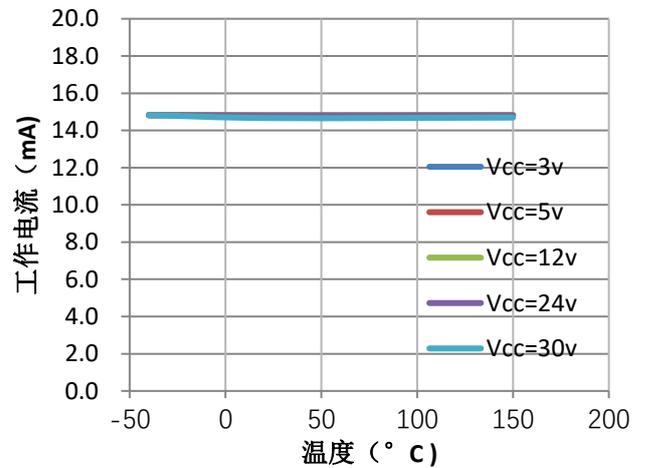
$V_{CC}=5V$ , 电源电流随温度变化特性曲线



$V_{CC}=3.0\sim 30V$ , 平均电源电流 (低) 输出特性曲线



$V_{CC}=3.0\sim 30V$ , 平均电源电流 (低) 输出特性曲线

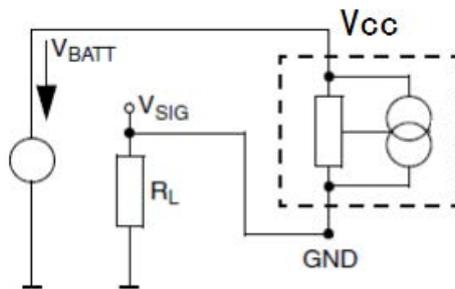




## 应用电路

下图显示了带有 2 线传感器的简单应用。可以通过测量  $R_L$  上的电压来检测电流消耗。为了使传感器正常工作， $V_{CC}$  和 GND 之间的电压必须至少为  $V_{CCMIN}$ 。在最大电流消耗为  $I_{CC-HIMAX}$  的情况下，最大  $R_L$  可以计算为：

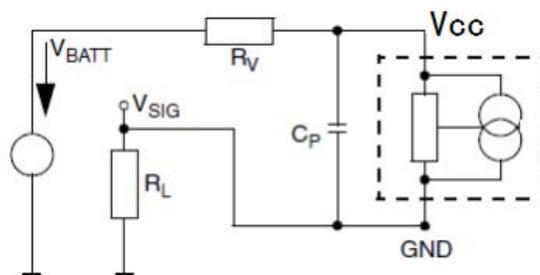
$$RL_{max} = \frac{VBATT_{min} - V_{CCmin}}{I_{cchimax}}$$



典型应用电路 (1)

对于电源线上有干扰或辐射干扰的应用，建议在传感器附近放置一个串联电阻  $R_V$  和一个电容  $C_P$ 。在这种情况下，最大  $R_L$  可计算为：

$$RL_{max} = \frac{VBATT_{min} - V_{CCmin}}{I_{cchimax}} - R_V$$



典型应用电路 (2)

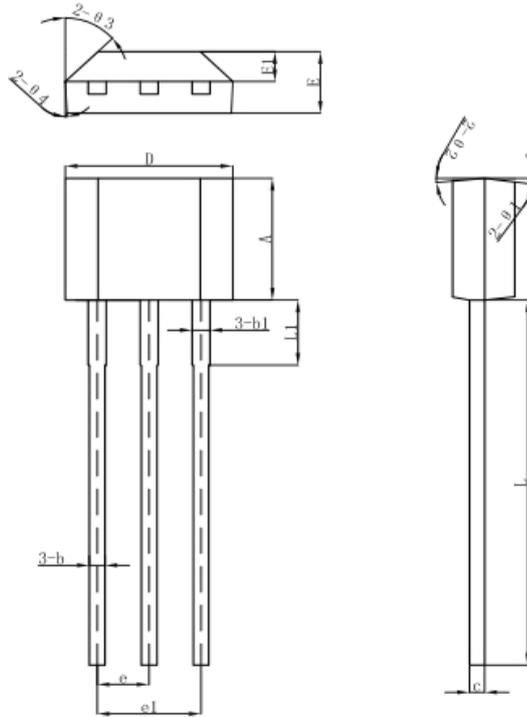
## 注意事项

- 霍尔芯片是敏感器件，在使用及存储过程中应注意采取静电防护措施。
- 在安装使用中应尽量减少施加到器件外壳和引线上的机械应力。
- 建议焊接温度不超过 350°C，持续时间不超过 5 秒。
- 为保证霍尔芯片的安全性和稳定性，不建议长期超出参数范围使用。



## 外形尺寸

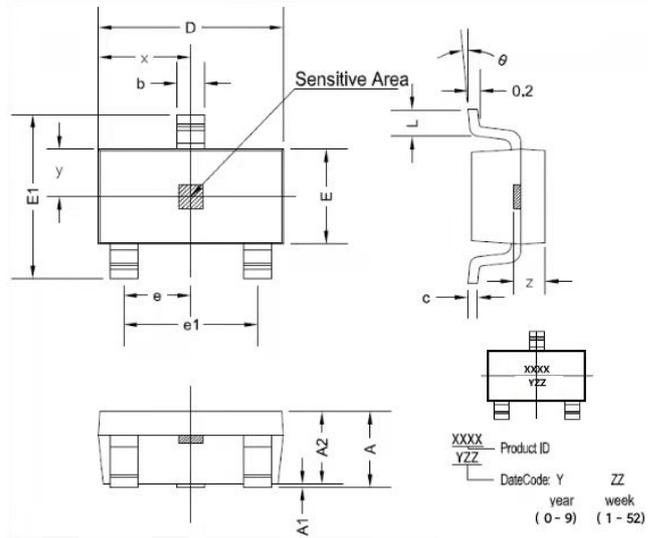
### TO-92S 封装尺寸



| 符号 | 机械尺寸/mm |       |       |
|----|---------|-------|-------|
|    | 最小      | 典型    | 最大    |
| A  | 2.90    | 3.00  | 3.10  |
| b  | 0.35    | 0.39  | 0.40  |
| b1 |         | 0.44  |       |
| c  | 0.36    | 0.38  | 0.40  |
| D  | 4.00    | 4.10  | 4.20  |
| E  | 1.42    | 1.52  | 1.62  |
| E1 |         | 0.75  |       |
| e  |         | 1.27  |       |
| e1 |         | 1.27  |       |
| L1 |         | 2.54  |       |
| L  | 13.50   | 14.50 | 15.50 |
| θ1 |         | 6°    |       |
| θ2 |         | 3°    |       |
| θ3 |         | 45°   |       |
| θ4 |         | 3°    |       |
| h  |         | 3.6   |       |



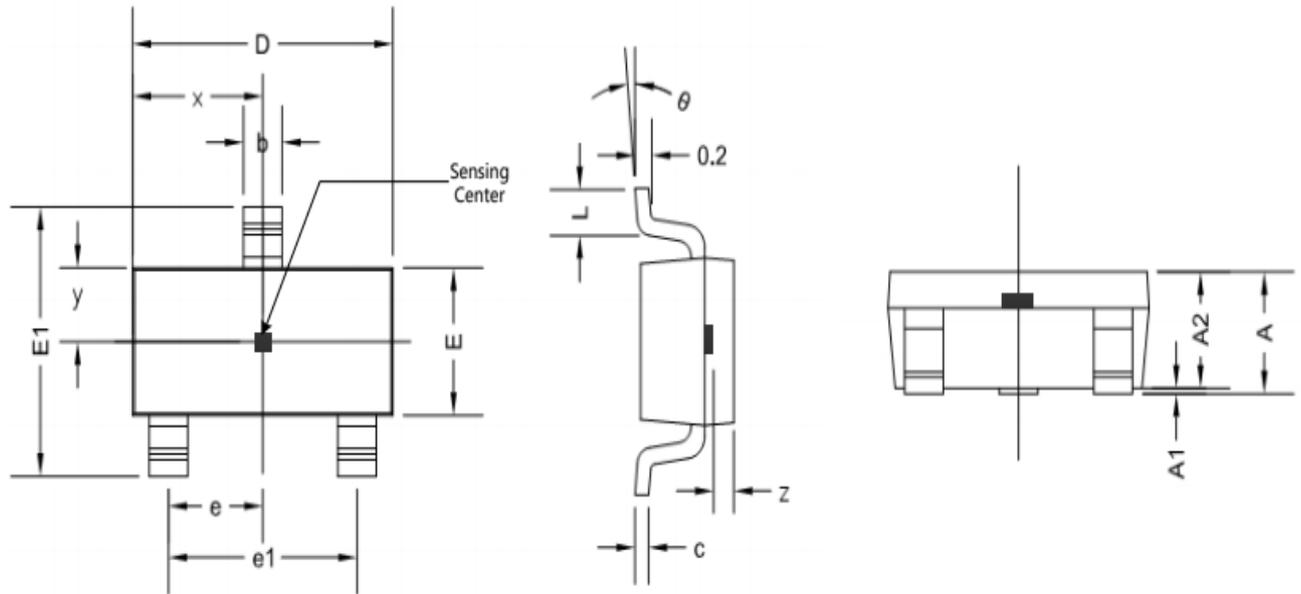
SOT-23-3L 封装尺寸



| 符号 | 尺寸 (毫米)   |      | 尺寸 (英尺)   |       |
|----|-----------|------|-----------|-------|
|    | 最小        | 最大   | 最小        | 最大    |
| A  | 1.05      | 1.25 | 0.041     | 0.049 |
| A1 | 0         | 0.1  | 0         | 0.004 |
| A2 | 1.05      | 1.15 | 0.041     | 0.045 |
| b  | 0.3       | 0.5  | 0.012     | 0.02  |
| c  | 0.100     | 0.2  | 0.004     | 0.008 |
| D  | 2.82      | 3.02 | 0.111     | 0.119 |
| E  | 1.5       | 1.7  | 0.059     | 0.067 |
| E1 | 2.65      | 2.95 | 0.104     | 0.116 |
| e  | 0.950 TYP |      | 0.037 TYP |       |
| e1 | 1.8       | 2    | 0.071     | 0.079 |
| L  | 0.3       | 0.6  | 0.012     | 0.024 |
| x  | 1.460 TYP |      | 0.057 TYP |       |
| y  | 0.800 TYP |      | 0.032 TYP |       |
| z  | 0.600 TYP |      | 0.024 TYP |       |
| θ  | 0°        | 8°   | 0°        | 8°    |



SOT-23封装尺寸



| 符号       | 尺寸 (毫米)  |       | 尺寸 (英寸)  |       |
|----------|----------|-------|----------|-------|
|          | 最小值      | 最大值   | 最小值      | 最大值   |
| A        | 0.900    | 1.150 | 0.035    | 0.045 |
| A1       | 0.000    | 0.100 | 0.000    | 0.004 |
| A2       | 0.900    | 1.100 | 0.035    | 0.043 |
| b        | 0.300    | 0.500 | 0.012    | 0.020 |
| c        | 0.132    | 0.202 | 0.005    | 0.008 |
| D        | 2.800    | 3.000 | 0.110    | 0.118 |
| E        | 1.200    | 1.400 | 0.047    | 0.055 |
| E1       | 2.250    | 2.550 | 0.089    | 0.100 |
| e        | 0.950TYP |       | 0.037TYP |       |
| e1       | 1.800    | 2.000 | 0.071    | 0.079 |
| L        | 0.300    | 0.500 | 0.012    | 0.020 |
| x        | 1.460TYP |       | 0.057TYP |       |
| y        | 0.650TYP |       | 0.026TYP |       |
| z        | 0.500TYP |       | 0.020TYP |       |
| $\theta$ | 0°       | 8°    | 0°       | 8°    |



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